CMOS Digital Integrated Circuits Silicon Monolithic

# TC7SB3157CFU

#### 1. Functional Description

Single 1-of-2 Multiplexer/Demultiplexer

#### 2. General

The TC7SB3157CFU is a high-speed CMOS single 1-of-2 multiplexer/demultiplexer. The low ON resistance of the switch allows connections to be made with minimal propagation delay time.

This device is 1 to 2 multiplexer/demultiplexer controlled by the select input (S). The A input is connected to B1 or B2 output based on the selection of Control input (S).

All inputs are equipped with protection circuits against static discharge.

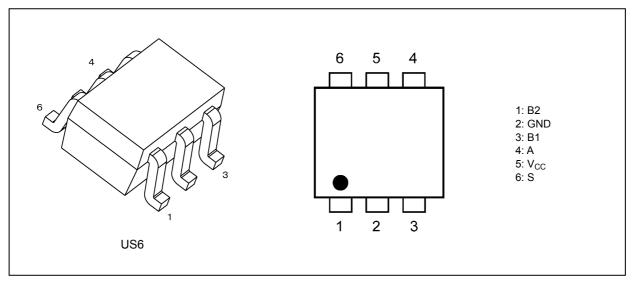
#### 3. Features

- (1) AEC-Q100 (rev.H) Grade 1 qualified (Note 1)
- (2) Wide operating temperature range:  $T_{opr}$  = -40 to 125 °C (Note 2)
- (3) Operating voltage:  $V_{CC}$  = 1.65 to 5.5 V
- (4) ON capacitance:  $C_{I/O} = 15 \text{ pF}$  Switch On (typ.)  $@V_{CC} = 5.0 \text{ V}$
- (5) ON resistance:  $R_{ON} = 4 \Omega$  (typ.) @V<sub>CC</sub> = 4.5 V, V<sub>IS</sub> = 0 V
- (6) Package: US6

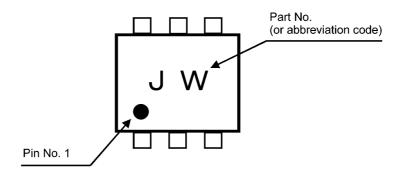
Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

Note 2: For devices with the ordering part number ending in (CT.  $T_{opr}$  = -40 to 85 °C for the other devices.

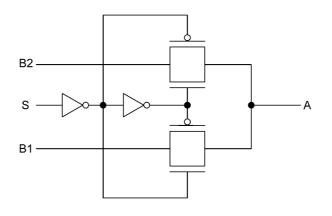
#### 4. Packaging and Pin Assignment



# 5. Marking



### 6. Block Diagram



## 7. Principle of Operation

### 7.1. Truth Table

Inputs S	Function
L	A port = B1 port
Н	A port = B2 port

# 8. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage (S)	V <sub>IN</sub>		-0.5 to 7.0	]
Switch I/O voltage	Vs		-0.5 to V <sub>CC</sub> +0.5	]
Clamp diode current	l <sub>IK</sub>		-50	mA
Switch I/O current	I <sub>S</sub>		50	]
Power dissipation	PD		200	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>		±100	mA
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

# 9. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		1.65 to 5.5	V
Input voltage (S)	V <sub>IN</sub>		0 to 5.5	
Switch I/O voltage	Vs		0 to V <sub>CC</sub>	
Operating temperature	T <sub>opr</sub>	(Note 1)	-40 to 125	°C
		(Note 2)	-40 to 85	
Input rise time	dt/dv		0 to 10	ns/V
Input fall time	dt/dv		0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either  $V_{CC}$  or GND.

Note 1: For devices with the ordering part number ending in (CT.

Note 2: For devices except those with the ordering part number ending in (CT.

## **10. Electrical Characteristics**

## 10.1. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	VIH		_	1.65 to 1.95	$0.8\times V_{CC}$	_		V
				2.3 to 5.5	$0.7\times V_{CC}$		_	
Low-level input voltage	VIL		—	1.65 to 1.95	_	_	$0.2 \times V_{CC}$	V
				2.3 to 5.5	_	_	$0.3 \times V_{CC}$	
Input leakage current	I <sub>IN</sub>		V <sub>IN</sub> = 0 to 5.5 V	1.65 to 5.5	_	_	±1.0	μA
Switch OFF-state leakage current	I <sub>SZ</sub>		B1, B2 = 0 to V <sub>CC</sub>	1.65 to 5.5	_	_	±10	μA
ON-resistance	R <sub>ON</sub>		V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 30 mA	4.5	—	4	7	Ω
		(Note 2)	V <sub>IS</sub> = 2.4 V, I <sub>IS</sub> = 30 mA	4.5	_	5	12	
			V <sub>IS</sub> = 4.5 V, I <sub>IS</sub> = 30 mA	4.5	_	6	10	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 24 mA	3.0	_	5	9	
			V <sub>IS</sub> = 3.0 V, I <sub>IS</sub> = 24 mA	3.0	_	7	14	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 8 mA	2.3	_	6	12	
			V <sub>IS</sub> = 2.3 V, I <sub>IS</sub> = 8 mA	2.3	_	9	18	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 4 mA	1.65	_	8	20	
			V <sub>IS</sub> = 1.65 V, I <sub>IS</sub> = 4 mA	1.65		15	30	
Quiescent supply	I <sub>CC</sub>		$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	5.5			10	μA
current	$\Delta I_{CC}$		V <sub>IN</sub> = V <sub>CC</sub> - 0.6 V	5.5		_	50	

Note 1: All typical values are at T<sub>a</sub> = 25 °C.

Note 2: Measured by the voltage drop between A and B pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two (A or B) pins.

### 10.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C)

Characteristics	Symbol	Note	Test Condition	$V_{CC}$ (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>		_	1.65 to 1.95	0.8×V <sub>CC</sub>	_	V
				2.3 to 5.5	0.7×V <sub>CC</sub>	_	
Low-level input voltage	V <sub>IL</sub>		_	1.65 to 1.95	_	0.2×V <sub>CC</sub>	V
				2.3 to 5.5	_	0.3×V <sub>CC</sub>	
Input leakage current	I <sub>IN</sub>		V <sub>IN</sub> = 0 to 5.5 V	1.65 to 5.5	_	±2.0	μA
Switch OFF-state leakage current	I <sub>SZ</sub>		B1, B2 = 0 to V <sub>CC</sub>	1.65 to 5.5	—	±20	
ON-resistance	R <sub>ON</sub>	(Note 1)	V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 30 mA	4.5	_	9	Ω
			V <sub>IS</sub> = 2.4 V, I <sub>IS</sub> = 30 mA	4.5	_	14	
			V <sub>IS</sub> = 4.5 V, I <sub>IS</sub> = 30 mA	4.5	_	12	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 24 mA	3.0	—	11	
			V <sub>IS</sub> = 3.0 V, I <sub>IS</sub> = 24 mA	3.0	_	16	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 8 mA	2.3	_	15	
			V <sub>IS</sub> = 2.3 V, I <sub>IS</sub> = 8 mA	2.3	_	21	
			<sub>IS</sub> = 0 V, I <sub>IS</sub> = 4 mA	1.65	_	23	
			V <sub>IS</sub> = 1.65 V, I <sub>IS</sub> = 4 mA	1.65	_	33	
Quiescent supply	I <sub>CC</sub>		$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	5.5	_	100	μA
current	Δl <sub>CC</sub>		V <sub>IN</sub> = V <sub>CC</sub> - 0.6 V	5.5	_	100	

Note 1: Measured by the voltage drop between A and B pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two (A or B) pins.

#### 10.3. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
3-state output enable time	t <sub>PZL</sub> /		See Fig. 10.2.1, 10.2.2,	$5.0\pm0.5$	_	4	ns
	t <sub>PZH</sub>		Table 10.2.1.	$\textbf{3.3}\pm\textbf{0.3}$	_	6	
				$2.5\pm0.2$	_	8	
				$1.8\pm0.15$		16	
3-state output disable time	t <sub>PLZ</sub> /		See Fig. 10.2.1, 10.2.2,	$5.0\pm0.5$	_	4.5	ns
	t <sub>PHZ</sub>		Table 10.2.1.	$\textbf{3.3}\pm\textbf{0.3}$	_	7	
				$2.5\pm0.2$	_	9	
				$1.8\pm0.15$	_	16	

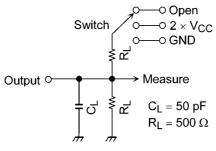
#### 10.4. AC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 125 ℃)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
3-state output enable time	t <sub>PZL</sub> /		See Fig. 10.2.1, 10.2.2,	$5.0\pm0.5$	_	6	ns
	t <sub>PZH</sub>		Table 10.2.1.	$\textbf{3.3}\pm\textbf{0.3}$	_	8	
				$2.5\pm0.2$	_	10	
				$1.8\pm0.15$	_	18	
3-state output disable time	t <sub>PLZ</sub> /		See Fig. 10.2.1, 10.2.2,	$5.0\pm0.5$	_	6.5	ns
	t <sub>PHZ</sub>		Table 10.2.1.	$3.3\pm0.3$	_	9	
				$2.5\pm0.2$	_	11	
				$1.8\pm0.15$		18	

## 10.5. Capacitive Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	$V_{CC}$ (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	(Note 1)	V <sub>IN</sub> = 0 V	5.0	4	pF
Switch terminal OFF-capacitance (B port)	C <sub>I/O</sub>		V <sub>I/O</sub> = 0 V	5.0	5	
Switch terminal ON-capacitance (A port)				5.0	15	
Switch terminal ON-capacitance (B port)				5.0	15	

Note 1: Parameter guaranteed by design.



#### Fig. 10.2.1 AC Test Circuit

#### Table 10.2.1 Parameter for AC Test Circuit

Parameter	Switch
t <sub>PLZ</sub> , t <sub>PZL</sub>	$2 \times V_{CC}$
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND

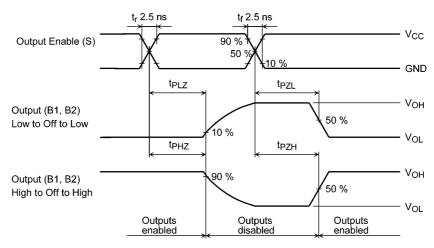


Fig. 10.2.2 AC Waveform tPLZ, tPHZ, tPZL, tPZH

## 11. Rise and Fall Time (tr/tf)

The  $t_{r(out)}$  and  $t_{f(out)}$  values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance ( $C_{I/O}$ ) and the on-resistance ( $R_{ON}$ ) of the input.

In practice, the  $t_{r(out)}$  and  $t_{f(out)}$  values are also affected by the circuit's capacitance and resistance components other than the capacitance of TC7SB3157CFU

The  $t_{\rm r}/t_{f(out)}$  values can be approximated as follows.

(Figure 11.1, Table 11.1 shows the test circuit.)

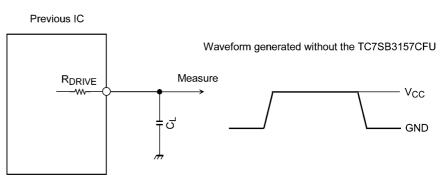
 $t_r / t_{f(out)} \text{ (approx)} = - (C_{I/O} + C_L) + (R_{DRIVE} + R_{ON}) + \ln (((V_{OH} - V_{OL}) - V_M) / (V_{OH} - V_{OL}))$ Where,  $R_{DRIVE}$  is the output impedance of the previous-stage circuit.

Calculation example:

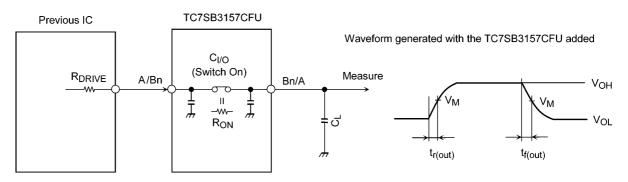
 $t_{r(out)} \text{ (approx)} = -(15 + 15) \text{ E} - 12 + (120 + 4) + \ln(((4.5 - 0) - 2.25) / (4.5 - 0)) \approx 2.6 \text{ ns}$ 

Calculation conditions:

 $V_{CC}$  = 4.5 V,  $C_L$  = 15 pF,  $R_{DRIVE}$  = 120  $\Omega$  (output impedance of the previous IC),  $V_M$  = 2.25 V ( $V_{CC}$ /2) Output of the previous IC = digital (i.e., high-level voltage =  $V_{CC}$ , low-level voltage = GND)



 $R_{DRIVE}$  = output impedance of the previous IC

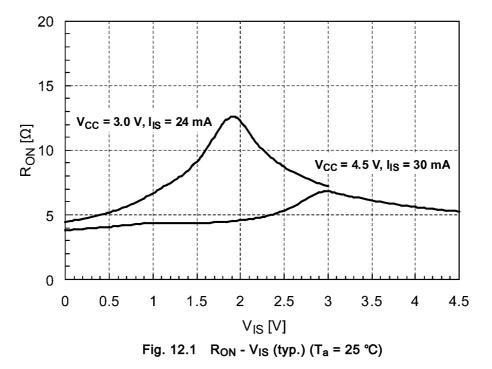


 $R_{DRIVE}$  = output impedance of the previous IC

Fig. 11.1 Calculation Circuit

Characteristics	$V_{CC}$ = 5.0 $\pm$ 0.5 V
V <sub>M</sub>	V <sub>CC</sub> /2

# 12. Characteristics Curves (Note)

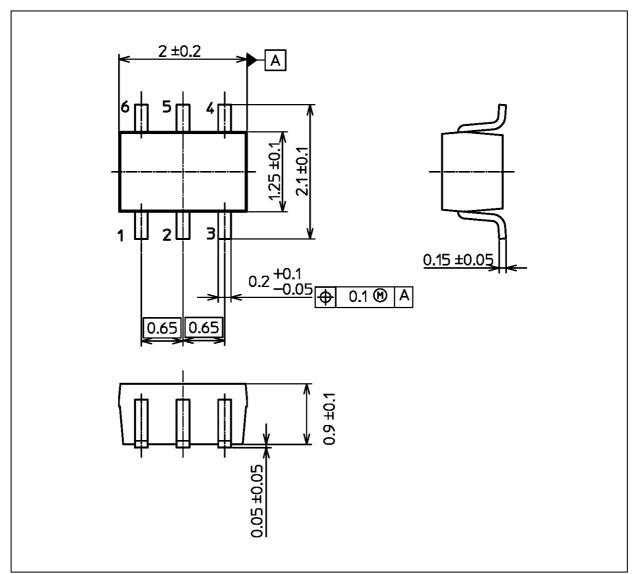


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



#### **Package Dimensions**

Unit: mm



Weight: 0.007 g (typ.)

	Package Name(s)
JEDEC: SOT-363	
Nickname: US6	

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